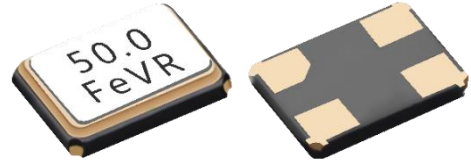


RH

- ▶ 5.0*3.2*0.8mm 4P 金属封装
- ▶ ±10PPM 高精度、高频率稳定性
- ▶ 滚边焊、满足无铅焊接的回流温度曲线要求
- ▶ -40°C ~ +85°C, 优良的耐环境性
- ▶ 符合 RoHS、Reach 认证标准



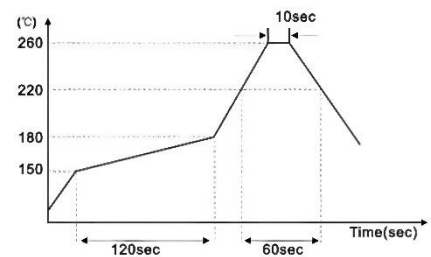
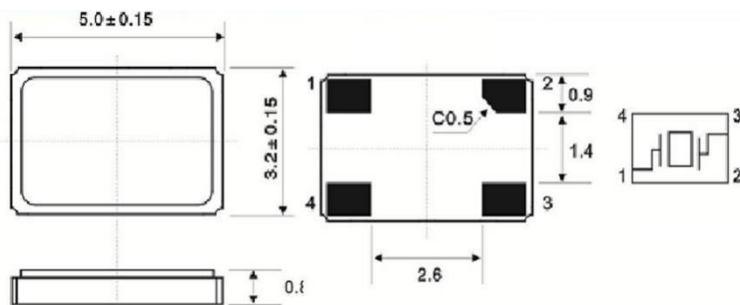
技术参数 Technical Parameter

频率范围	Frequency Range	8.000MHz ~ 54.000MHz
振动模式	Mode	FUND
频率偏差	Frequency Deviation	±10ppm ~ ±30ppm
频率温度特性	Frequency Temperature Characteristics	±10ppm ~ ±30ppm
工作温度范围	Operating Temperature Range	-40°C ~ +85°C, or specify
储存温度范围	Storage temperature Range	-40°C ~ +85°C
老化率	Aging Rate	±3ppm / year
负载电容	Load Capacitance	8pF, 10pF, 12pF, or specify
静电容	Static Capacitance	<3pf
谐振电阻	Resonance Resistance	见下表 / SEE PAGE
激励电平	Drive Level	Typ.100μW

谐振电阻 Resonance Resistance

频率范围	谐振电阻
8.0MHz ~ 10.0MHz	100Ω MAX
10.0MHz ~ 20.0MHz	60Ω MAX
20.0MHz ~ 30.0MHz	40Ω MAX
30.0MHz ~ 54.0MHz	30Ω MAX

外观尺寸 Dimension(Unit:mm)



Solder melting point: 220°C
Total time: 200sec Max